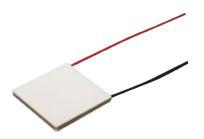
# Thermoelectric Module





### Scope:

This specification is applied to multicomp thermoelectric modules Revision of these specifications is carried out after consent.

## **Specifications:**

Pa	Remarks			
Internal resistance	1.4Ω ±	Note-1		
I max.	13 <i>A</i>	Note-2		
V max.	24.1	Note-3		
-	Th = 27°C	Th = 50°C	-	
Q max.	200W	224W	Note-4	
ΔT max.	68°C	75°C	Note-5	
Solder melting point	138°	Note-6		
Maximum compress	98.07N / cm² (	Note-7		

Note-1: Measured by AC 4 - terminal method at 25°C

Note-2 : Maximum current at  $\Delta T$  max. Note-3 : Maximum voltage at  $\Delta T$  max.

Note-4 : Maximum cooling capacity at I max. V max. and  $\Delta T = 0$ °C

Note-5 : Maximum temperature difference at I max. V max. and Q = 0W (Maximum parameters are measured in a vacuum 1.3 P)

Note-6: The solder melting point of thermoelectric module

Note-7: Recommended maximum compression (not destruction limit)

#### Recommendations:

- Operating range : -40°C to +90°C
- Dropping or exerting mechanical shock will cause breakage, take care in handling
- Thinly spread thermally conductive grease should be placed between module and heat exchanger Surface deviation from flatness should be kept under 0.02mm
- For optimum reliability and performance it is recommended that the module be utilised <0.7I max. Silicone sealed for moisture protection





# Thermoelectric Module multicomp PRO



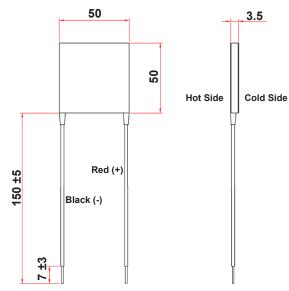
### **Specification Table**

Thot =  $27^{\circ}C$ 

I max. (A)	U max. (V)	Qc max. W	dT max. °C	Α	В	Н	Part Number
13	24.1	200	68	50	50	3.5	MCTE1-19913L-S

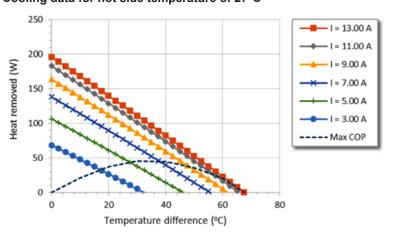
Dimensions: Millimetres

### **Outline Drawing:**



**Dimensions: Millimetres** 

### Cooling data for hot side temperature of 27°C



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